

ABSTRACT

ELECTRONIC DEVICE HANDLER FOR A BONDING APPARATUS

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A bonding apparatus is provided which includes a device handler for handling electronic devices, the bonding apparatus including a bonding tool at which the electronic devices are locatable for bonding. A storage assembly is provided for storing multiple electronic devices and a conveying track is further provided for

10 conveying electronic devices towards and away from the bonding tool. The device handler includes a rotary platform for holding an electronic device, and which is operable between an orientation wherein the rotary platform is aligned with the conveying track for transferring an electronic device between the rotary platform and the conveying track, and another orientation wherein the rotary

15 platform is aligned with the storage assembly for transferring an electronic device between the rotary platform and the storage assembly.

(FIG. 2(a))